

DI

DISCONTINUED
THIS DEVICE IS NOT RECOMMENDED

DI



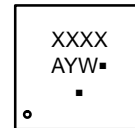
MSOP8 3.0x3.0
CASE 846AQ
ISSUE O

DATE 22 SEP 2020

c	0.105	0.125	
E1			

**RECOMMENDED
MOUNTING FOOTPRINT**

**GENERIC
MARKING DIAGRAM***



- XXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



TSSOP8, 4.4x3.0, 0.65P
CASE 948AL
ISSUE A

DATE 20 MAY 2022

3. DIMENSION **b** DOES NOT INCLUDE ^{_RS}DAMBAR PROTRUSI

TOP VIEW

DIM	MILLIMETERS		
	MIN.	NOM.	
A	---		1.20
A1	0.05		0.15
A2			
b	0.19		0.30
c			
D	2.90		3.10
E	6.3		
E1	4.30		4.50
e			
θ			

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